

Digital Integrated Circuits By Thomas A Demassa

For those with a basic understanding of digital design, this book teaches the essential skills to design digital integrated circuits using Verilog and the relevant extensions of SystemVerilog. In addition to covering the syntax of Verilog and SystemVerilog, the author provides an appreciation of design challenges and solutions for producing working circuits. The book covers not only the syntax and limitations of HDL coding, but deals extensively with design problems such as partitioning and synchronization, helping you to produce designs that are not only logically correct, but will actually work when turned into physical circuits. Throughout the book, many small examples are used to validate concepts and demonstrate how to apply design skills. This book takes readers who have already learned the fundamentals of digital design to the point where they can produce working circuits using modern design methodologies. It clearly explains what is useful for circuit design and what parts of the languages are only software, providing a non-theoretical, practical guide to robust, reliable and optimized hardware design and development. Produce working hardware: Covers not only syntax, but also provides design know-how, addressing problems such as synchronization and partitioning to produce working solutions Usable examples: Numerous small examples throughout the book demonstrate concepts in an easy-to-grasp manner Essential knowledge: Covers the vital design topics of synchronization, essential for producing working silicon; asynchronous interfacing techniques; and design techniques for circuit optimization, including partitioning

This book, first published in 2004, is an expanded and revised edition of Tom Lee's acclaimed RFIC text.

Unlike books currently on the market, this book attempts to satisfy two goals: combine circuits and electronics into a single, unified treatment, and establish a strong connection with the contemporary world of digital systems. It will introduce a new way of looking not only at the treatment of circuits, but also at the treatment of introductory coursework in engineering in general. Using the concept of "abstraction," the book attempts to form a bridge between the world of physics and the world of large computer systems. In particular, it attempts to unify electrical engineering and computer science as the art of creating and exploiting successive abstractions to manage the complexity of building useful electrical systems. Computer systems are simply one type of electrical systems. +Balances circuits theory with practical digital electronics applications. +Illustrates concepts with real devices. +Supports the popular circuits and electronics course on the MIT OpenCourse Ware from which professionals worldwide study this new approach. +Written by two educators well known for their innovative teaching and research and their collaboration with industry. +Focuses on contemporary MOS technology.

This book offers comprehensive coverage of a wide, relevant array of operational amplifier topics. KEY TOPICS: The book integrates theory, practical circuits, and troubleshooting concepts, keeping mathematical details to a minimum. Delving more deeply into coverage of operational amplifiers, the book guides readers through a system of pedagogical tools that both reinforces and challenges their understanding. An essential reference in electronic technology.

Noise Coupling is the root-cause of the majority of Systems on Chip (SoC) product fails. The book discusses a breakthrough substrate coupling analysis flow and modelling toolset, addressing the needs of the design community. The flow provides capability to analyze noise components, propagating through the substrate, the parasitic interconnects and the package. Using this book, the reader can analyze and avoid complex noise coupling that degrades RF and mixed signal design performance, while reducing the need for conservative design practices. With chapters written by leading international experts in the field, novel methodologies are provided to identify noise coupling in

silicon. It additionally features case studies that can be found in any modern CMOS SoC product for mobile communications, automotive applications and readout front ends.

Digital Integrated Circuits John Wiley & Sons Incorporated

VLSI Handbook is a reference guide on very large scale integration (VLSI) microelectronics and its aspects such as circuits, fabrication, and systems applications. This handbook readily answers specific questions and presents a systematic compilation of information regarding the VLSI technology. There are a total of 52 chapters in this book and are grouped according to the fields of design, materials and processes, and examples of specific system applications. Some of the chapters under fields of design are design automation for integrated circuits and computer tools for integrated circuit design. For the materials and processes, there are many chapters that discuss this aspect. Some of them are manufacturing process technology for metal-oxide semiconductor (MOS) VLSI; MOS VLSI circuit technology; and facilities for VLSI circuit fabrication. Other concepts and materials discussed in the book are the use of silicon material in different processes of VLSI, nitrides, silicides, metallization, and plasma. This handbook is very useful to students of engineering and physics. Also, researchers (in physics and chemistry of materials and processes), device designers, and system designers can also benefit from this book.

The impact of digital integrated circuits on our modern society has been pervasive. They are the enabling technology of the current computer and information-technology revolution. This is largely true because of the immense amount of signal and computer processing that can be realized in a single integrated circuit; modern IC's may contain millions of logic gates. This text book is intended to take a reader having only a minimal background and knowledge in electronics to the point where they can design state-of-the-art digital integrated circuits. Designing high-performance digital integrated circuits requires expertise in many different areas. These include semiconductor physics, integrated circuit processing, transistor-level design, logic-level design, system-level design, testing, etc. Aspects of these topics are covered throughout this text, although the emphasis is on transistor-level design of digital integrated circuits and systems. This is in contrast to the perspective in many other texts, which takes a system-level or VLSI approach where transistor-level details are minimized. It is the author's belief that before system-level considerations can be properly evaluated, an in-depth transistor-level understanding must first be obtained. Important system-level considerations such as timing, pipelining, clock distribution, and system building blocks are covered in detail, but the emphasis on transistors first.

Throughout the book, physical and intuitive explanations are given, and although mathematical quantitative analysis of many circuits have necessarily been presented, Martin has attempted not to "miss seeing the forest because of the trees". This book presents the critical underlying concepts without becoming entangled in tedious and over-complicated circuit analyses. It is intended for senior/graduate level students in electrical and computer engineering. This course assumes the Sedra/Smith Microelectronic Circuits course as a prerequisite.

Power analysis attacks allow the extraction of secret information from smart cards. Smart cards are used in many

applications including banking, mobile communications, pay TV, and electronic signatures. In all these applications, the security of the smart cards is of crucial importance. Power Analysis Attacks: Revealing the Secrets of Smart Cards is the first comprehensive treatment of power analysis attacks and countermeasures. Based on the principle that the only way to defend against power analysis attacks is to understand them, this book explains how power analysis attacks work. Using many examples, it discusses simple and differential power analysis as well as advanced techniques like template attacks. Furthermore, the authors provide an extensive discussion of countermeasures like shuffling, masking, and DPA-resistant logic styles. By analyzing the pros and cons of the different countermeasures, this volume allows practitioners to decide how to protect smart cards.

Achieve enhanced performance with this guide to cutting-edge techniques for digitally-assisted analog and analog-assisted digital integrated circuit design. • Discover how architecture and circuit innovations can deliver improved performance in terms of speed, density, power, and cost • Learn about practical design considerations for high-performance scaled CMOS processes, FinFet devices and architectures, and the implications of FD SOI technology • Get up to speed with established circuit techniques that take advantage of scaled CMOS process technology in analog, digital, RF and SoC designs, including digitally-assisted techniques for data converters, DSP enabled frequency synthesizers, and digital controllers for switching power converters. With detailed descriptions, explanations, and practical advice from leading industry experts, this is an ideal resource for practicing engineers, researchers, and graduate students working in circuit design.

Covers the major electrical and electronic concepts involved in integrated circuits and explains how semiconductors work designer for new challenges that might be waiting around the corner. Design-oriented perspectives are advocated throughout. Design challenges and guidelines are h... The publisher, Prentice-Hall

Engineering/Science/Mathematics Progressive in content and form, this practical text successfully bridges the gap between the circuit perspective and system perspective of digital integrated circuit design. Beginning with solid discussions on the operation of electronic devices and and in-depth analysis of the nucleus of digital design, the text maintains a consistent, logical flow of subject matter throughout, addressing today's most significant and compelling industry topics: the impact of interconnect, design for low power, issues

A Must-Read for all RF/RFIC Circuit Designers This book targets the four most difficult skills facing RF/RFIC designers today: impedance matching, RF/AC grounding, Six Sigma design, and RFIC technology. Unlike most books on the market, it presents readers with practical engineering design examples to explore how they're used to solve ever more complex problems. The content is divided into three key parts: Individual RF block circuit design Basic RF circuit design

skills RF system engineering The author assumes a fundamental background in RF circuit design theory, and the goal of the book is to enable readers to master the correct methodology. The book includes treatment of special circuit topologies and introduces some useful schemes for simulation and layout. This is a must-read for RF/RFIC circuit design engineers, system designers working with communication systems, and graduates and researchers in related fields. This book reviews the state of the art of very high speed digital integrated circuits. Commercial applications are in fiber optic transmission systems operating at 10, 40, and 100 Gb/s, while the military application is ADCs and DACs for microwave radar. The book contains detailed descriptions of the design, fabrication, and performance of wideband Si/SiGe-, GaAs-, and InP-based bipolar transistors. The analysis, design, and performance of high speed CMOS, silicon bipolar, and III-V digital ICs are presented in detail, with emphasis on application in optical fiber transmission and mixed signal ICs. The underlying physics and circuit design of rapid single flux quantum (RSFQ) superconducting logic circuits are reviewed, and there is extensive coverage of recent integrated circuit results in this technology. Contents: Preface (M J W Rodwell); High-Speed and High-Data-Bandwidth Transmitter and Receiver for Multi-Channel Serial Data Communication with CMOS Technology (M Fukaishi et al.); High-Performance Si and SiGe Bipolar Technologies and Circuits (M Wurzer et al.); Self-Aligned Si BJT/SiGe HBT Technology and Its Application to High-Speed Circuits (K Washio); Small-Scale InGaP/GaAs Heterojunction Bipolar Transistors for High-Speed and Low-Power Integrated-Circuit Applications (T Oka et al.); Prospects of InP-Based IC Technologies for 100-Gbit/s-Class Lightwave Communications Systems (T Enoki et al.); Scaling of InGaAs/InAlAs HBTs for High Speed Mixed-Signal and mm-Wave ICs (M J W Rodwell); Progress Toward 100 GHz Logic in InP HBT IC Technology (C H Fields et al.); Cantilevered Base InP DHBT for High Speed Digital Applications (A L Gutierrez-Aitken et al.); RSFQ Technology: Physics and Devices (P Bunyk et al.); RSFQ Technology: Circuits and Systems (D K Brock). Readership: Researchers, industrialists and academics in electrical and electronic engineering.

This book presents several circuits that are required for the full integration of an optical transmitter in standard CMOS. The main emphasis is placed on high-speed receivers with a bitrate of up to 1 Gb/s. The possibility of including the photodiode in a receiver is investigated and the problems encountered are discussed.

Top-down approach to practical, tool-independent, digital circuit design, reflecting how circuits are designed.

This book provides practical solutions for delay and power reduction for on-chip interconnects and buses. It provides an in depth description of the problem of signal delay and extra power consumption, possible solutions for delay and glitch removal, while considering the power reduction of the total system. Coverage focuses on use of the Schmitt Trigger as an alternative approach to buffer insertion for delay and power reduction in VLSI interconnects. In the last section of the book, various bus coding techniques are discussed to minimize delay and power in address and data buses.

This book provides broad and comprehensive coverage of the entire EDA flow. EDA/VLSI practitioners and researchers in need of fluency in an "adjacent" field will find this an invaluable reference to the basic EDA concepts, principles, data structures, algorithms, and architectures for the design, verification, and test of VLSI circuits. Anyone who needs to learn the concepts, principles, data structures, algorithms, and architectures of the EDA flow will benefit from this book. Covers complete spectrum of the EDA flow, from ESL design modeling to logic/test synthesis, verification, physical design, and test - helps EDA newcomers to get "up-and-running" quickly Includes comprehensive coverage of EDA concepts, principles, data structures, algorithms, and architectures - helps all readers improve their VLSI design competence Contains latest advancements not yet available in other books, including Test compression, ESL design modeling, large-scale floorplanning, placement, routing, synthesis of clock and power/ground networks - helps readers to design/develop testable chips or products Includes industry best-practices wherever appropriate in most chapters - helps readers avoid costly mistakes

Modern wireless communications hardware is underpinned by RF and microwave design techniques. This insightful book contains a wealth of circuit layouts, design tips, and practical measurement techniques for building and testing practical gigahertz systems. The book covers everything you need to know to design, build, and test a high-frequency circuit. Microstrip components are discussed, including tricks for extracting good performance from cheap materials. Connectors and cables are also described, as are discrete passive components, antennas, low-noise amplifiers, oscillators, and frequency synthesizers. Practical measurement techniques are presented in detail, including the use of network analyzers, sampling oscilloscopes, spectrum analyzers, and noise figure meters. Throughout the focus is practical, and many worked examples and design projects are included. There is also a CD-ROM that contains a variety of design and analysis programs. The book is packed with indispensable information for students taking courses on RF or microwave circuits and for practising engineers.

Mixed-Signal Circuits offers a thoroughly modern treatment of integrated circuit design in the context of mixed-signal applications. Featuring chapters authored by leading experts from industry and academia, this book: Discusses signal integrity and large-scale simulation, verification, and testing Demonstrates advanced design techniques that enable digital circuits and sensitive analog circuits to coexist without any compromise Describes the process technology needed to address the performance challenges associated with developing complex mixed-signal circuits Deals with modeling topics, such as reliability, variability, and crosstalk, that define pre-silicon design methodology and trends, and are the focus of companies involved in wireless applications Develops methods to move analog into the digital domain quickly, minimizing and eliminating common trade-offs between performance, power consumption, simulation time, verification, size, and cost Details approaches for very low-power performances, high-speed interfaces, phase-locked loops (PLLs), voltage-controlled oscillators (VCOs), analog-to-digital converters (ADCs), and biomedical filters Delineates the respective parts of a full system-on-chip (SoC), from the digital parts to the baseband blocks, radio frequency (RF) circuitries, electrostatic-discharge (ESD) structures, and built-in self-test (BIST) architectures Mixed-Signal Circuits explores exciting opportunities in wireless communications and beyond. The book is a must for anyone involved in mixed-signal circuit design for future technologies.

A transistor-level, design-intensive overview of high speed and high frequency monolithic integrated circuits for wireless and broadband systems from 2 GHz to 200 GHz, this comprehensive text covers high-speed, RF, mm-wave, and optical fibre circuits using nanoscale CMOS, SiGe BiCMOS, and III-V technologies. Step-by-step design methodologies, end-of chapter problems, and practical simulation and design projects are provided, making this an ideal resource for senior undergraduate and graduate courses in circuit design. With an emphasis on device-circuit topology interaction and optimization, it gives circuit designers and students alike an in-depth understanding of

device structures and process limitations affecting circuit performance.

Exponential improvement in functionality and performance of digital integrated circuits has revolutionized the way we live and work. The continued scaling down of MOS transistors has broadened the scope of use for circuit technology to the point that texts on the topic are generally lacking after a few years. The second edition of Digital Integrated Circuits: Analysis and Design focuses on timeless principles with a modern interdisciplinary view that will serve integrated circuits engineers from all disciplines for years to come. Providing a revised instructional reference for engineers involved with Very Large Scale Integrated Circuit design and fabrication, this book delves into the dramatic advances in the field, including new applications and changes in the physics of operation made possible by relentless miniaturization. This book was conceived in the versatile spirit of the field to bridge a void that had existed between books on transistor electronics and those covering VLSI design and fabrication as a separate topic. Like the first edition, this volume is a crucial link for integrated circuit engineers and those studying the field, supplying the cross-disciplinary connections they require for guidance in more advanced work. For pedagogical reasons, the author uses SPICE level 1 computer simulation models but introduces BSIM models that are indispensable for VLSI design. This enables users to develop a strong and intuitive sense of device and circuit design by drawing direct connections between the hand analysis and the SPICE models. With four new chapters, more than 200 new illustrations, numerous worked examples, case studies, and support provided on a dynamic website, this text significantly expands concepts presented in the first edition.

With vastly increased complexity and functionality in the "nanometer era" (i.e. hundreds of millions of transistors on one chip), increasing the performance of integrated circuits has become a challenging task. Connecting effectively (interconnect design) all of these chip elements has become the greatest determining factor in overall performance. 3-D integrated circuit design may offer the best solutions in the near future. This is the first book on 3-D integrated circuit design, covering all of the technological and design aspects of this emerging design paradigm, while proposing effective solutions to specific challenging problems concerning the design of 3-D integrated circuits. A handy, comprehensive reference or a practical design guide, this book provides a sound foundation for the design of 3-D integrated circuits. * Demonstrates how to overcome "interconnect bottleneck" with 3-D integrated circuit design...leading edge design techniques offer solutions to problems (performance/power consumption/price) faced by all circuit designers * The FIRST book on 3-D integrated circuit design...provides up-to-date information that is otherwise difficult to find * Focuses on design issues key to the product development cycle...good design plays a major role in exploiting the implementation flexibilities offered in the 3-D * Provides broad coverage of 3-D integrated circuit design, including interconnect prediction models, thermal management techniques, and timing optimization...offers practical view of designing 3-D circuits

This book provides a detailed treatment of radiation effects in electronic devices, including effects at the material, device, and circuit levels. The emphasis is on transient effects caused by single ionizing particles (single-event effects and soft errors) and effects produced by the cumulative energy deposited by the radiation (total ionizing dose effects). Bipolar (Si and SiGe), metalOxideOxide semiconductor (MOS), and compound semiconductor technologies are discussed. In addition to considering the specific issues associated with high-performance devices and technologies, the book includes the background material necessary for understanding radiation effects at a more general level. Contents: Single Event Effects in Avionics and on the Ground (E Normand); Soft Errors in Commercial Integrated Circuits (R C Baumann); System Level Single Event Upset Mitigation Strategies (W F Heidergott); Space Radiation Effects in Optocouplers (R A Reed et al.); The Effects of Space Radiation Exposure on Power MOSFETs: A Review (K Shenai et al.); Total Dose Effects in Linear Bipolar Integrated Circuits (H J Barnaby); Hardness Assurance for Commercial Microelectronics (R L Pease); Switching Oxide Traps (T R Oldham); Online and Realtime Dosimetry Using Optically Stimulated Luminescence (L Dusseau & J Gasiot); and other articles. Readership: Practitioners, researchers, managers and graduate students in electrical and electronic engineering, semiconductor science and technology, and microelectronics."

Contains the most extensive coverage of digital integrated circuits available in a single source. Provides complete qualitative descriptions of circuit operation followed by in-depth analytical analyses and spice simulations. The circuit families described in detail are transistor-transistor logic (TTL, STTL, and ASTTL), emitter-coupled logic (ECL), NMOS logic, CMOS logic, dynamic CMOS, BiCMOS structures and various GASFET technologies. In addition to detailed presentation of the basic inverter circuits for each digital logic family, complete details of other logic circuits for these families are presented.

For the new millenium, Wai-Kai Chen introduced a monumental reference for the design, analysis, and prediction of VLSI circuits: The VLSI Handbook. Still a valuable tool for dealing with the most dynamic field in engineering, this second edition includes 13 sections comprising nearly 100 chapters focused on the key concepts, models, and equations.

Written by a stellar international panel of expert contributors, this handbook is a reliable, comprehensive resource for real answers to practical problems. It emphasizes fundamental theory underlying professional applications and also reflects key areas of industrial and research focus. WHAT'S IN THE SECOND EDITION? Sections on... Low-power electronics and design VLSI signal processing Chapters on... CMOS fabrication Content-addressable memory Compound semiconductor RF circuits High-speed circuit design principles SiGe HBT technology Bipolar junction transistor amplifiers Performance modeling and analysis using SystemC Design languages, expanded from two chapters to twelve Testing of digital systems Structured for convenient navigation and loaded with practical solutions, The VLSI Handbook, Second

Edition remains the first choice for answers to the problems and challenges faced daily in engineering practice. Mixed-Mode Simulation and Analog Multilevel Simulation addresses the problems of simulating entire mixed analog/digital systems in the time-domain. A complete hierarchy of modeling and simulation methods for analog and digital circuits is described. Mixed-Mode Simulation and Analog Multilevel Simulation also provides a chronology of the research in the field of mixed-mode simulation and analog multilevel simulation over the last ten to fifteen years. In addition, it provides enough information to the reader so that a prototype mixed-mode simulator could be developed using the algorithms in this book. Mixed-Mode Simulation and Analog Multilevel Simulation can also be used as documentation for the SPLICE family of mixed-mode programs as they are based on the algorithms and techniques described in this book.

This book describes the physical operation of the Tunnel Field-effect Transistor (TFET) and circuits built with this device. Whereas the majority of publications on TFETs describe in detail the device, its characteristics, variants and performance, this will be the first book addressing TFET integrated circuits (TFET ICs). The authors describe the peculiarities of TFET ICs and their differences with MOSFETs. They also develop and analyze a number of logic circuits and memories. The discussion also includes complex circuits combining CMOS and TFET, as well as a potential fabrication process in Silicon.

Welcome to the proceedings of PATMOS 2005, the 15th in a series of international workshops. PATMOS 2005 was organized by IMEC with technical co-sponsorship from the IEEE Circuits and Systems Society. Over the years, PATMOS has evolved into an important European event, where researchers from both industry and academia discuss and investigate the emerging challenges in future and contemporary applications, design methodologies, and tools required for the development of upcoming generations of integrated circuits and systems. The technical program of PATMOS 2005 contained state-of-the-art technical contributions, three invited talks, a special session on hearing-aid design, and an embedded tutorial. The technical program focused on timing, performance and power consumption, as well as architectural aspects with particular emphasis on modeling, design, characterization, analysis and optimization in the nanometer era. The Technical Program Committee, with the assistance of additional expert reviewers, selected the 74 papers to be presented at PATMOS. The papers were divided into 11 technical sessions and 3 poster sessions. As is always the case with the PATMOS workshops, the review process was anonymous, full papers were required, and several reviews were carried out per paper. Beyond the presentations of the papers, the PATMOS technical program was enriched by a series of speeches offered by world class experts, on important emerging research issues of industrial relevance. Prof. Jan Rabaey, Berkeley, USA, gave a talk on "Traveling the Wild Frontier of

Ultra Low-Power Design”, Dr. Sung Bae Park, S- sung, gave a presentation on “DVL (Deep Low Voltage): Circuits and Devices”, Prof.

This book is the first to give an authoritative and comprehensive account of the invention of Integrated Circuits (ICs) from an insider who had participated and contributed from the beginning of their invention and advancement to the Ultra Large Scale ICs (ULSICs) of today. It reads like a mystery novel to engross the reader, but it is not based on fiction; it gives documented facts of the invention of ICs, analyzes the patents, and highlights additional details and clarifications of their history. In addition, the book clarifies the Nobel Prize award and raises intriguing questions which as yet remain unanswered even after about half a century since the ICs were invented. This is the invention which has revolutionized the whole world forever!

Edited by acclaimed science writer and physicist James Trefil, the Encyclopedia's 1000 entries combine in-depth coverage with a vivid graphic format to bring every facet of science, technology, and medicine into stunning focus. From absolute zero to the Mesozoic era to semiconductors to the twin paradox, Trefil and his co-authors have an uncanny ability to convey how the universe works and to show readers how to apply that knowledge to everyday problems.

[Copyright: 571aac1c5c8a294d5c94bf742d4c8925](https://www.amazon.com/dp/B000APR000)